



IGBT in TRENCHSTOP™ and Fieldstop technology Low Loss IGBT:







Features:

- Very low $V_{\text{CE(sat)}}$ 1.5 V (typ.) Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs
- TRENCHSTOP™ and Fieldstop technology for 600V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
- Low EMI
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/





Applications:

- Variable Speed Drive for washing machines and air conditioners
- **Buck converters**

Туре	V _{CE}	I _{C;Tc=100°C}	V _{CE(sat), Tj=25°C}	$T_{\rm j,max}$	Marking	Package
IGD06N60T	600V	6A	1.5V	175°C	G06T60	PG-TO252-3

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, <i>T</i> _j ≥ 25°C	V _{CE}	600	V
DC collector current, limited by T_{jmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	I _C	12 6	A
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	18	
Turn off safe operating area, $V_{CE} = 600 \text{V}$, $T_j = 175 ^{\circ}\text{C}$, $t_p = 1 \mu\text{s}$	-	18	
Gate-emitter voltage	$V_{\rm GE}$	±20	V
Short circuit withstand time ²⁾ $V_{GE} = 15V, V_{CC} \le 400V, T_j \le 150^{\circ}C$	t_{SC}	5	μs
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P _{tot}	88	W
Operating junction temperature	$T_{\rm j}$	-40+175	
Storage temperature	$T_{\rm stg}$	-55+150	°C
Soldering temperature reflow soldering, MSL1		260	

¹ J-STD-020 and JESD-022

IFAG IPC TD VLS 1 Rev. 2.2, 20.09.2013

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.





Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	<u>.</u>			
IGBT thermal resistance,	R _{thJC}		1.7	K/W
junction – case				
Thermal resistance,	R_{thJA}		62	
junction – ambient				

Electrical Characteristic, at $T_i = 25$ °C, unless otherwise specified

Barrantan	Currely al	Conditions	Value			I I m i t
Parameter	Symbol	mbol Conditions		typ.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	V _{(BR)CES}	$V_{\text{GE}}=0\text{V},$ $I_{\text{C}}=0.25\text{mA}$	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE} = 15 \rm V, \ I_{\rm C} = 6 \rm A$				
		<i>T</i> _j =25°C	-	1.5	2.05	
		T _j =175°C	-	1.8		
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 0.18 {\rm mA}$	4.1	4.6	5.7	
		$V_{\text{CE}} = V_{\text{GE}}$				
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μΑ
		<i>T</i> _j =25°C	-	-	40	
		<i>T</i> _j =175°C	-	-	700	
Gate-emitter leakage current	I _{GES}	$V_{\text{CE}}=0\text{V}, V_{\text{GE}}=20\text{V}$	-	-	100	nA
Transconductance	g_{fs}	$V_{CE} = 20 \text{V}, I_{C} = 6 \text{A}$	-	3.6	-	S
Integrated gate resistor	R _{Gint}			none		Ω

Dynamic Characteristic

Input capacitance	Ciss	$V_{CE}=25V$,	-	368	-	pF
Output capacitance	Coss	$V_{GE}=0V$,	-	28	-	
Reverse transfer capacitance	Crss	f=1MHz	-	11	-	
Gate charge	Q _{Gate}	$V_{\rm CC} = 480 \text{V}, I_{\rm C} = 6 \text{A}$	-	42	-	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	7	-	nH
measured 5mm (0.197 in.) from case						
Short circuit collector current ¹⁾	$I_{C(SC)}$	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 5 \mu \text{s}$ $V_{\text{CC}} = 400 \text{V},$ $T_{\text{j}} = 25 ^{\circ} \text{C}$	-	55	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



IGD06N60T

TRENCHSTOP™ Series

Switching Characteristic, Inductive Load, at T_j =25 °C

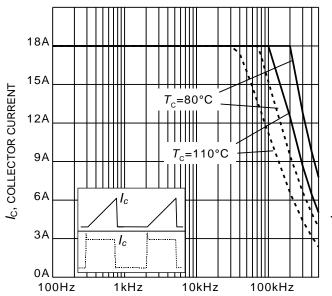
Danamatan	S: mah al	Conditions	Value			l lm!4
Parameter	Symbol		min.	typ.	max.	Unit
IGBT Characteristic	<u>.</u>					
Turn-on delay time	t _{d(on)}	$T_{\rm j}$ =25°C, $V_{\rm CC}$ =400V, $I_{\rm C}$ =6A, $V_{\rm GE}$ =0/15V, $I_{\rm G}$ =23 Ω , I_{σ} =60nH, I_{σ} =40pF	-	9	-	ns
Rise time	t _r		-	6	-	
Turn-off delay time	t _{d(off)}		-	130	-	
Fall time	t_{f}]	-	58	-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include "tail" and diode reverse	-	0.09	-	mJ
Turn-off energy	E _{off}		-	0.11	-	
Total switching energy	E _{ts}	recovery. Diode used IDP06E60	-	0.2	-	

Switching Characteristic, Inductive Load, at $T_{\rm j}$ =175 °C

Desembles	Cumbal	Conditions	Value			I Imit
Parameter	Symbol		min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_{\rm j}$ =175°C, $V_{\rm CC}$ =400V, $I_{\rm C}$ =6A, $V_{\rm GE}$ =0/15V, $I_{\rm G}$ =23 Ω I_{σ} =60nH, I_{σ} =40pF I_{σ} , I_{σ} 0 from Fig. E Energy losses include "tail" and diode reverse	-	9	-	ns
Rise time	$t_{\rm r}$		-	8	-	
Turn-off delay time	$t_{d(off)}$		-	165	•	
Fall time	t_{f}		-	84	-	
Turn-on energy	Eon		-	0.14	-	mJ
Turn-off energy	E _{off}		-	0.18	•	
Total switching energy	E _{ts}	recovery. Diode used IDP06E60	-	0.335		

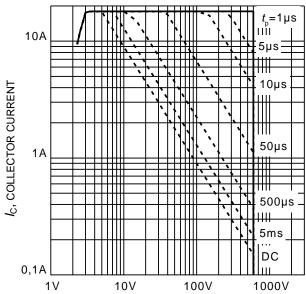






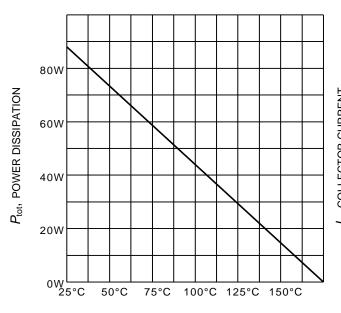
f, SWITCHING FREQUENCY

Figure 1. Collector current as a function of switching frequency $(T_j \le 175^{\circ}\text{C}, D = 0.5, V_{\text{CE}} = 400\text{V}, V_{\text{GE}} = 0/15\text{V}, r_{\text{G}} = 23\Omega)$



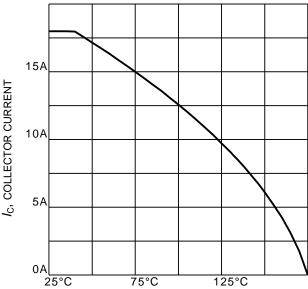
 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area $(D=0, T_C=25^{\circ}C, T_j \le 175^{\circ}C; V_{GE}=0/15V)$



 $T_{\rm C}$, CASE TEMPERATURE Figure 3. Power dissipation as a function of case temperature

 $(T_{i} \leq 175^{\circ}C)$



 $T_{\rm C}$, CASE TEMPERATURE

Figure 4. Collector current as a function of case temperature

 $(V_{GE} \ge 15V, T_i \le 175^{\circ}C)$





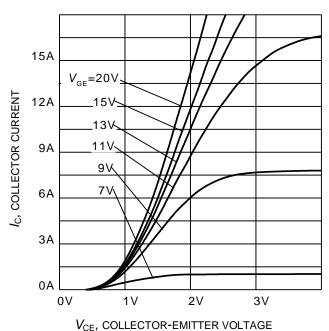


Figure 5. Typical output characteristic $(T_i = 25^{\circ}\text{C})$

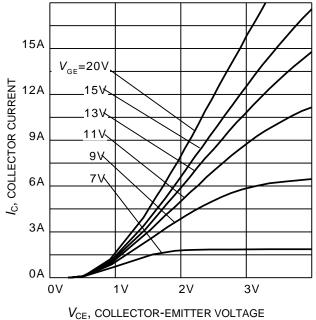


Figure 6. Typical output characteristic $(T_i = 175^{\circ}\text{C})$

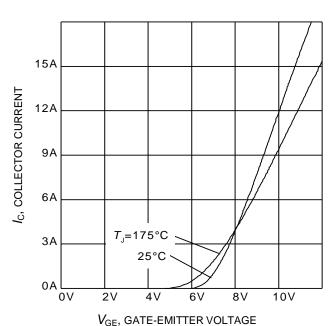
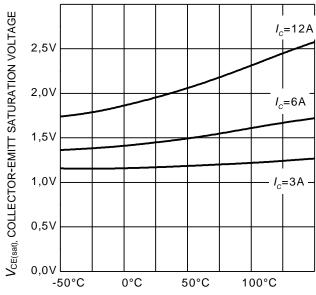


Figure 7. Typical transfer characteristic $(V_{CE}=20V)$



T_J, JUNCTION TEMPERATURE

Figure 8. Typical collector-emitter saturation voltage as a function of

junction temperature $(V_{GE} = 15V)$

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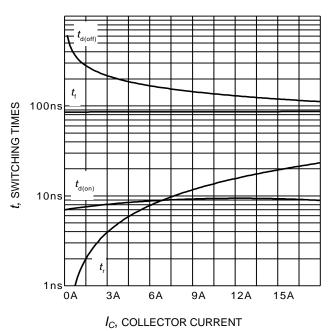


Figure 9. Typical switching times as a function of collector current (inductive load, T_J =175°C, V_{CE} = 400V, V_{GE} = 0/15V, r_G = 23 Ω , Dynamic test circuit in Figure E)

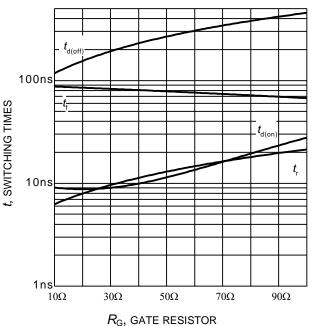


Figure 10. Typical switching times as a function of gate resistor (inductive load, T_J =175°C, V_{CE} = 400V, V_{GE} = 0/15V, I_C = 6A, Dynamic test circuit in Figure E)

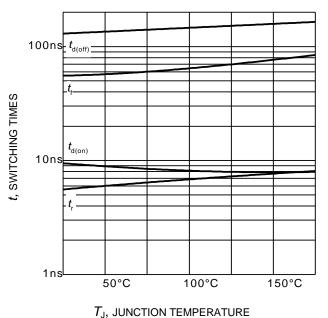


Figure 11. Typical switching times as a function of junction temperature (inductive load, $V_{\text{CE}} = 400\text{V}$, $V_{\text{GE}} = 0/15\text{V}$, $I_{\text{C}} = 6\text{A}$, $I_{\text{C}} = 23\Omega$, Dynamic test circuit in Figure E)

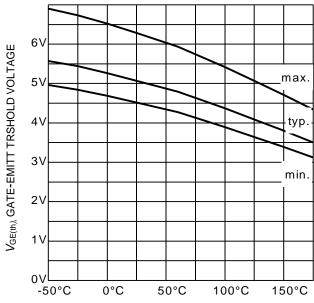
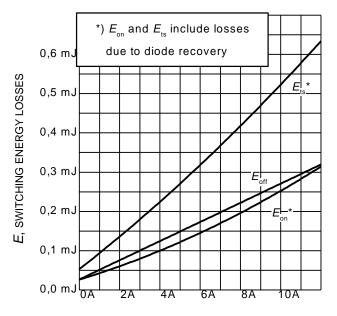


Figure 12. Gate-emitter threshold voltage as a function of junction temperature ($I_C = 0.18\text{mA}$)

 $T_{\rm J}$, JUNCTION TEMPERATURE

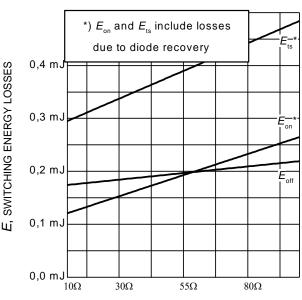






 I_{C} , COLLECTOR CURRENT

Figure 13. Typical switching energy losses as a function of collector current (inductive load, T_J =175°C, V_{CE} =400V, V_{GE} =0/15V, r_{G} =23 Ω , Dynamic test circuit in Figure E)



R_G, GATE RESISTOR

Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, T_J =175°C, $V_{CE} = 400$ V, $V_{GE} = 0/15$ V, $I_C = 6$ A, Dynamic test circuit in Figure E)

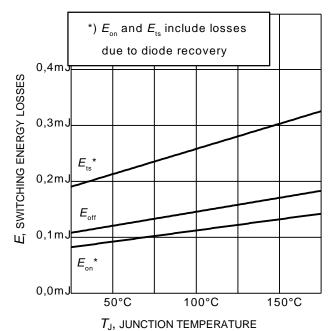
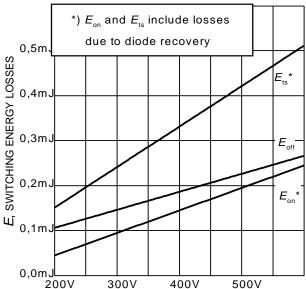


Figure 15. Typical switching energy losses as a function of junction temperature

(inductive load, $V_{\rm CE}$ =400V, $V_{\rm GE}$ = 0/15V, $I_{\rm C}$ = 6A, $r_{\rm G}$ = 23 Ω , Dynamic test circuit in Figure E)



 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load, T_J = 175°C, V_{GE} = 0/15V, I_C = 6A, r_G = 23 Ω , Dynamic test circuit in Figure E)





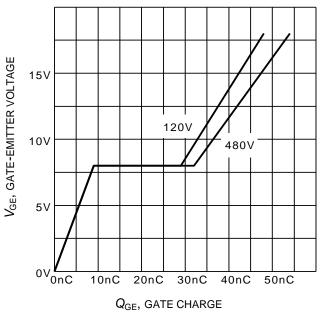
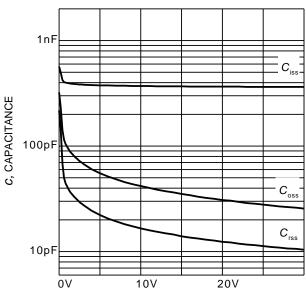


Figure 17. Typical gate charge $(I_C = 6 \text{ A})$



 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f=1 \text{ MHz})$

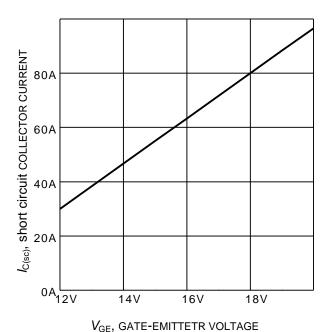
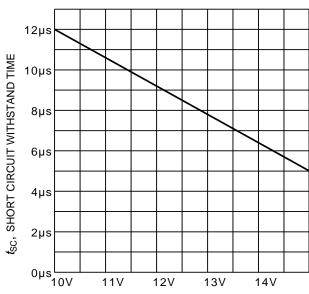


Figure 19. Typical short circuit collector current as a function of gate-emitter voltage $(V_{CE} \le 400 \text{V}, T_i \le 150 ^{\circ}\text{C})$



 $V_{\rm GE}$, gate-emitetr voltage

Figure 20. Short circuit withstand time as a function of gate-emitter voltage (V_{CE} =400V, start at T_{J} =25°C, T_{Jmax} <150°C)





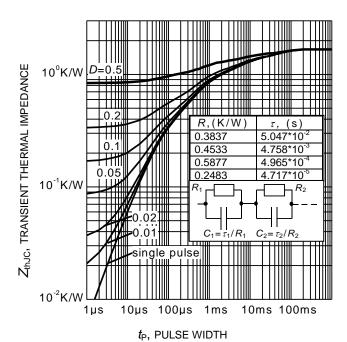
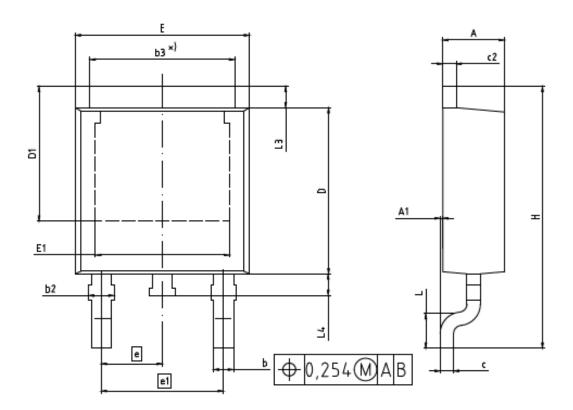
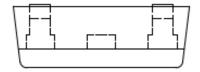


Figure 21. IGBT transient thermal impedance $(D = t_p / T)$



Package Drawing PG-TO252-3





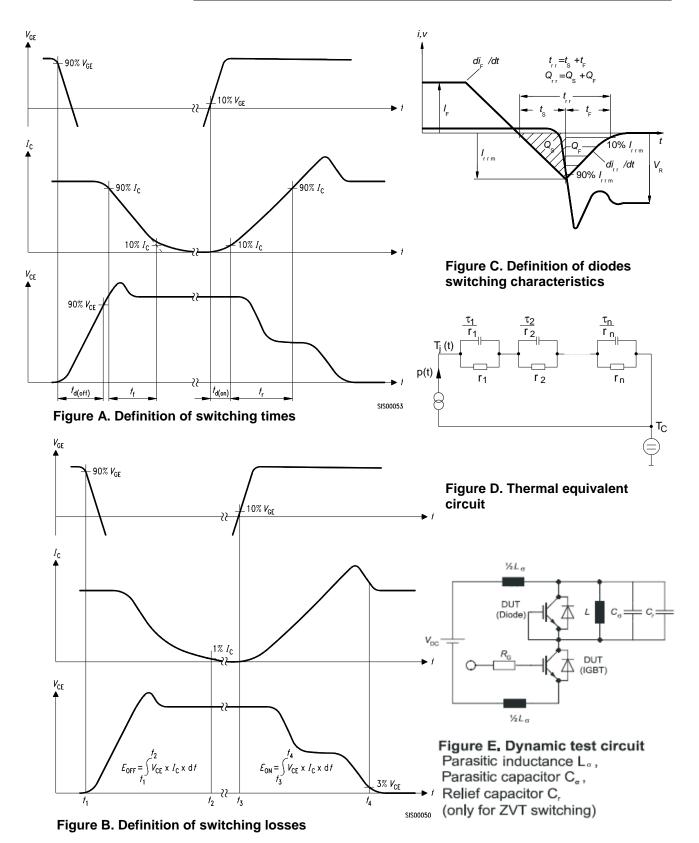
DIM	MILLIM	ETERS		
Dine	MIN	MAX		
A	2.16	2.41		
A1	0.00	0.15		
b	0.64	0.89		
b2	0.65	1.15		
b3	4,95	5.50		
e	0.46	0.61		
c2	0.40	0.98		
D	5.97	6.22		
D1	5.02	5.84		
E	6.35	6.73		
E1	4.32 5.21			
e		29 (BSC)		
e1	4.	.57 (BSC)		
N		3		
Н	9.40 10.48			
L	1.18 1.78			
L3	0.89	1.27		
L4	0.51	1.02		

NOTES: 1. ALL DIMENSIONS REFER TO JEDEC STANDARD TO-252 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

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EUROPEAN PROJECTION
$\stackrel{\bigoplus}{\bigoplus}$
05-02-2016
REVISION 06









IGD06N60T

TRENCHSTOP™ Series

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